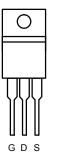


HM32N20-VB Datasheet

N-Channel 200 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)		
200	0.058at V _{GS} = 10 V	35		

TO-220AB

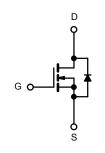


FEATURES

- TrenchFET[®] Power MOSFETS
- 175 °C Junction Temperature
- New Low Thermal Resistance Package
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

Industrial



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V _{DS}	200	V			
Gate-Source Voltage	V _{GS}	± 20	v			
Continuous Drain Current (T ₁ = 175 °C)	T _C = 25 °C		35			
Continuous Drain Current (1j = 175°C)	T _C = 125 °C	I _D	23	•		
Pulsed Drain Current	I _{DM}	70	- A			
Avalanche Current	I _{AR}	35				
Repetitive Avalanche Energy ^a	L = 0.1 mH	E _{AR}	61	mJ		
	T _C = 25 °C	D	300 ^b	14/		
Maximum Power Dissipation ^a	T _A = 25 °C ^c	– P _D –	3.75	- W		
Operating Junction and Storage Temperature Ra	ange	T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W		
Junction-to-Case (Drain)	R _{thJC}	0.5			

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When mounted on 1" square PCB (FR-4 material).

SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min .	Тур.	Max.	Unit	
Static			200				
Drain-Source Breakdown Voltage	V _{DS}	V _{DS} = 0 V, I _D = 250 μA				v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2		4	-	
Gate-Body Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 30 V			± 250	nA	
Zero Gate Voltage Drain Current		V_{DS} = 200 V, V_{GS} = 0 V			1	μA	
	I _{DSS}	V_{DS} = 200 V, V_{GS} = 0 V, T_{J} = 125 °C			50		
		V_{DS} = 200 V, V_{GS} = 0 V, T_{J} = 175 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 V$, V_{GS} = 10 V	70			А	
		V _{GS} = 10 V, I _D = 20 A		0.058		1	
		V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.130		-	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 175 °C		0.170		Ω	
		V _{GS} = 6 V, I _D = 15 A		0.070			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		70		S	
Dynamic ^b				ļ	I		
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		2690		pF	
Output Capacitance	C _{oss}			200			
Reverse Transfer Capacitance	C _{rss}			110			
Total Gate Charge ^c	Qg			95	140	nC	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 100 V, V_{GS} = 10 V, I_{D} = 45 A		28			
Gate-Drain Charge ^c	Q _{gd}			34			
Gate Resistance	R _g	f = 1 MHz		1.6		Ω	
Turn-On Delay Time ^c	t _{d(on)}			22	35		
Rise Time ^c	t _r	V _{DD} = 100 V, R _L = 2.78 Ω		220	330		
Turn-Off Delay Time ^c	t _{d(off)}	${\sf I}_{\sf D}\cong$ 45 A, ${\sf V}_{\sf GEN}$ = 10 V, ${\sf R}_{\sf g}$ = 2.5 Ω		40	60	ns	
Fall Time ^c	t _f			145	220		
Source-Drain Diode Ratings and Cha	aracteristics (T _C = 25 °C) ^b					
Continuous Current	ا _S				45		
Pulsed Current	I _{SM}				70	A	
Forward Voltage ^a	V _{SD}	I _F = 45 A, V _{GS} = 0 V		1	1.5	V	
Reverse Recovery Time	t _{rr}			150	225	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 45 A, di/dt = 100 A/μs		12	18	А	
Reverse Recovery Charge	Q _{rr}			0.9	2	μC	

Notes:

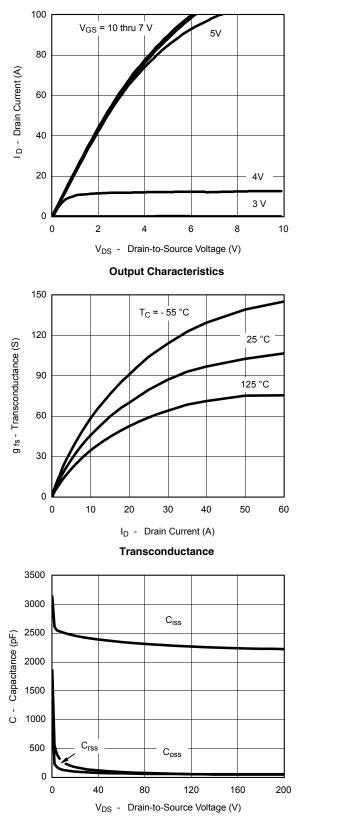
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

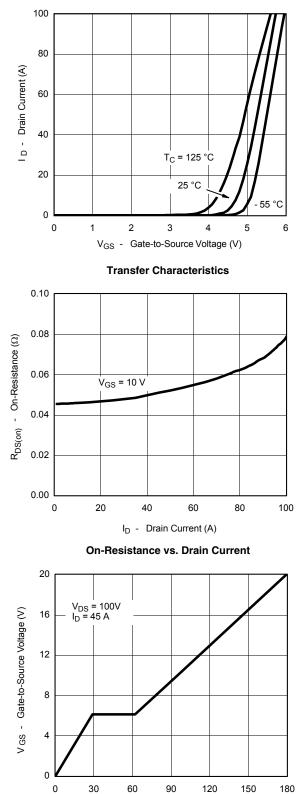
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



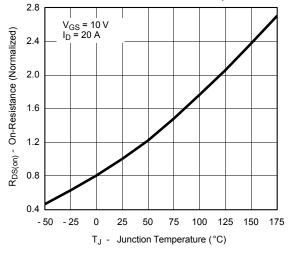


Qg - Total Gate Charge (nC)

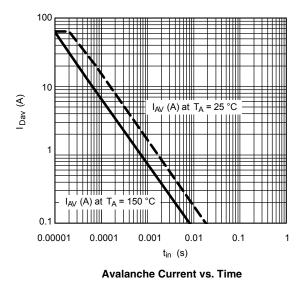


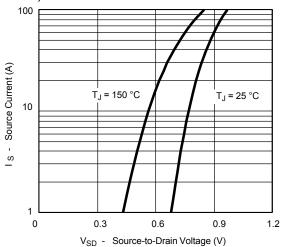


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

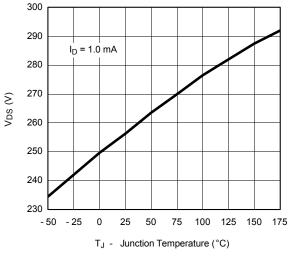


On-Resistance vs. Junction Temperature





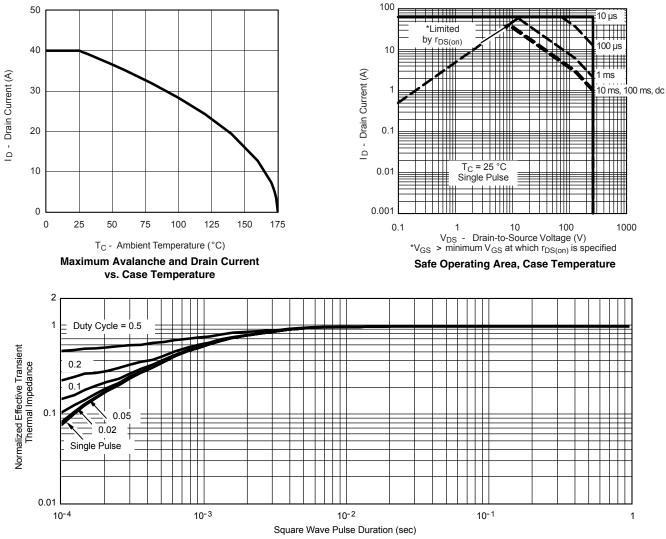
Source-Drain Diode Forward Voltage



Drain Source Breakdown vs. Junction Temperature



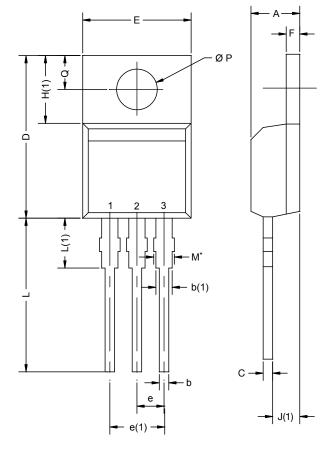
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



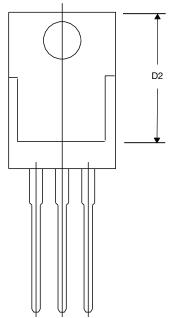
TO-220AB



	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
D2	12.19	12.70	0.480	0.500	
E	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: T14-0413-Rev. P, 16-Jun-14 DWG: 5471					

Note

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM





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